	09-19-2005				
Ö,	Form PTO-1595 RECC (Rev. 10/02) OMB No. 0651-0027 (exp. 6/30/2005)			U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office	
	Tab settings ⇔⇔ ♥ ▼	10308	3884	▼	
	To the Honorable Commissioner of Patents and			al documents or copy thereof.	
ئى	Name of conveying party(ies):		2. Name and address of receiving party(ies) Name: M~MOS Sdn. Bhd. O		
	Fwu-Iuan Hshieh		Internal Address:	a	
	Additional name(s) of conveying party(ies) attached? The Yes No			60	
	3. Nature of conveyance:			5.7	
	Assignment		Street Address: 1 Si	licon Drive	
	Security Agreement Ghange Other	of Name	Sama Jaya Free	Industrial Zone	
	- Other			Sarawak, Malaysia _State:Zip:	
•	Execution Date: Sept. 5, 2005		Additional name(s) & addres	ss(es) attached? 📮 Yes 🔯 No	
	If this document is being filed together with A. Patent Application No.(s) Addition		B. Patent No.(s)	2005	
	Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved:		
			o. Total number of applications and patents involved.		
	Name: Bo-In Lin	7. 1	7. Total fee (37 CFR 3.41)\$ 40.00		
	Internal Address: 2005 ECOOPER 00000113 11223621 Street Address: 13445 Mandoli Drive CityLos Altos Hills, CA Zip: 94022		Enclosed Authorized to be charged to deposit account 8. Deposit account number:		
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	Ching-lu Lin	Signature Sept. 10, 2005			
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Mail documents to be recorded with required cover sheet information to:

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, . .

Docket No.MMOS-0505

ASSIGNMENT

INVENTOR AND CITY Whereas, I, Fwu-Iuan Hshieh of

Saratoga, California 95070

have invented:

TTTLE:

HIGH DENSITY HYBRID MOSFET DEVICE

DATE INVENTOR SIGNED THE DECLARATION

and executed a United States patent application therefor

Whereas, M-MOS Sdn. Bhd., having a place of business at Sarawak, Malaysia, (hereinafter called M-MOS), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to M-MOS, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to M-MOS its successors and assigns; and I hereby agree that M-MOS may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sarawak, Malaysia

DATE

SIGNATURE OF INVENTOR

PATENT REEL: 016985 FRAME: 0639